



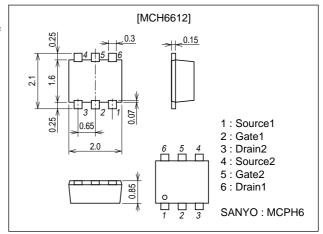
# **Ultrahigh-Speed Switching Applications**

### **Features**

- · Low ON-resistance.
- · Ultrahigh-speed switching.
- · 4V drive.
- Composite type with 2 MOSFETs contained in a single package, facilitating high-density mounting.

# **Package Dimensions**

unit : mm 2173A



# **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		50	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		0.45	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	1.8	Α
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm <sup>2</sup> X 0.8mm)1unit	0.8	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			1.1:4
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =1mA, V <sub>G</sub> S=0	50			٧
Zero-Gate Voltage Drain Current	IDSS	VDS=50V, VGS=0			10	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =100μA	1		2.4	V
Forward Transfer Admittance	yfs	VDS=10V, ID=100mA	220	310		mS
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	I <sub>D</sub> =100mA, V <sub>G</sub> S=10V		1.8	2.3	Ω
	Rps(on)2	In=50mA, Vgs=4V		2.3	3.2	Ω

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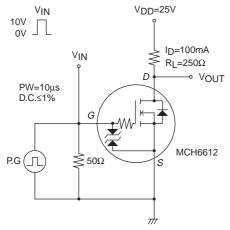
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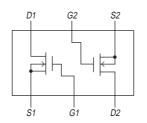
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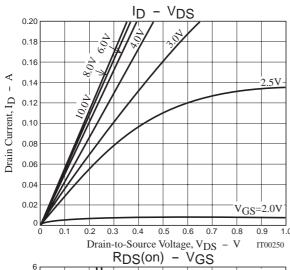
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Input Capacitance	Ciss	V <sub>DS</sub> =10V, f=1MHz		22		pF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		12		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		4.6		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		12		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit.		12		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		260		ns
Fall Time	tf	See specified Test Circuit.		110		ns
Total Gate Charge	Qg	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =200mA		1.86		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =200mA		0.28		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =200mA		0.45		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =200mA, V <sub>GS</sub> =0		0.83	1.2	V

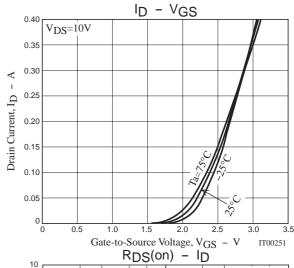
## **Switching Time Test Circuit**

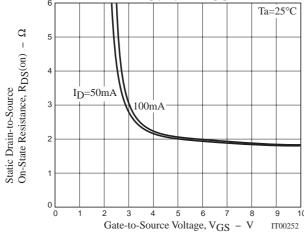
## **Electrical Connection**

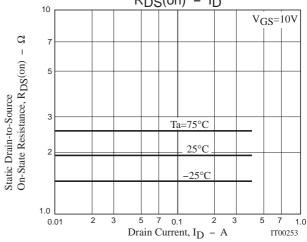


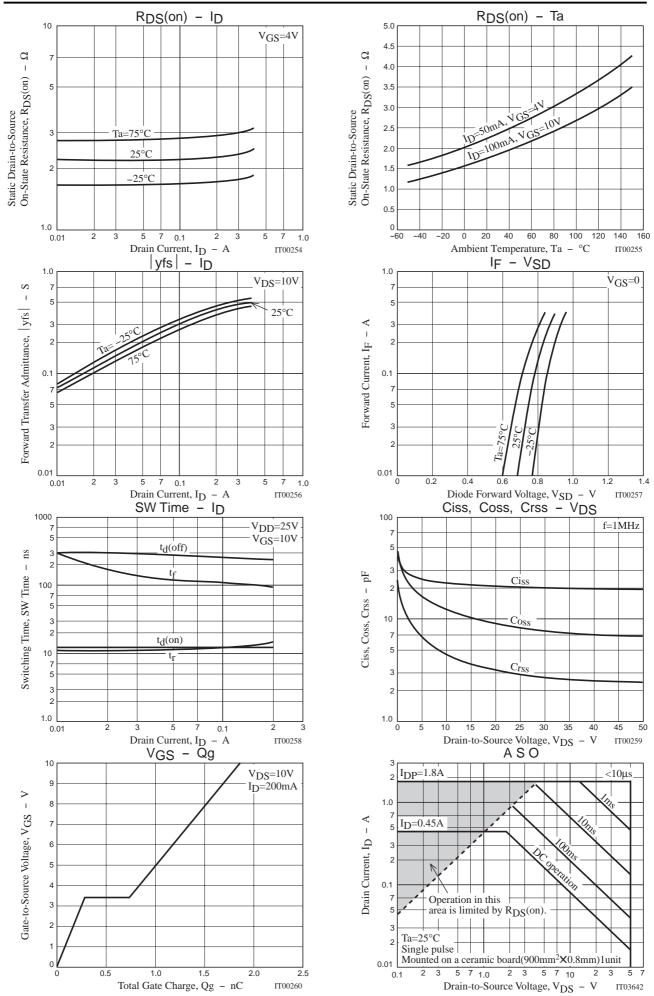


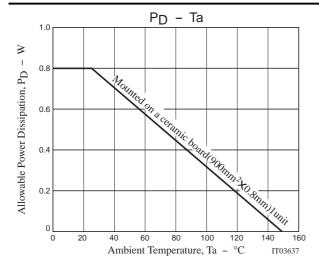












Note on usage: Since the MCH6612 is designed for high-speed switching applications, please avoid using this device in the vicinity of highly charged objects.

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